Shoe insole laminated

Detail Introduction :

| Product description

The compounding of insoles generally involves the compounding between materials such as mesh, leathe EVA foam or TPU foam, and the bonding strength requirements are relatively high after compounding. Bef hot melt adhesive film process became popular, glue was commonly used for lamination, which was not on environmentally friendly, but also had dripping problems, affecting the workshop environment and workers With the development and production of hot melt adhesive film without base material in the hot melt adhes industry, the cost of the hot melt adhesive film process has been reduced, making it possible to replace tra glue laminated insoles with hot melt adhesive film. The hot melt film process is simple, easy to use, and re little or no modification in equipment. The benefits are environmentally friendly, clean production, and, from comprehensive cost perspective, cost reduction.

EVA hot melt film or TPU hot melt film is often used for the lamination of insoles, depending on the materia insole to be bonded. Generally EVA foam material is used EVA hot melt adhesive film, TPU foam material TPU hot melt adhesive film for bonding. According to the specific requirements of the bonding, generally c thickness of no base material hot melt adhesive film products within 5 filaments.

Shanghai Hengning New Material Co., Ltd. is engaged in the application development and research of environmental protection hot melt adhesive products, with many years of industry service experience, if yo more related hot melt adhesive film application problems, or material bonding problems, you are welcome us at any time!